

July 1989 Revised August 1999

# 74F640 • 74F645 Octal Bus Transceiver with 3-STATE Outputs

#### **General Description**

These devices are octal bus transceivers designed for asynchronous two-way data flow between the A and B busses. Both busses are capable of sinking 64 mA, have 3-STATE outputs, and a common output enable pin. The direction of data flow is determined by the transmit/receive ( $T/\overline{R}$ ) input. The 74F645 is a high speed/low power version of the 74F245. The 74F640 is an inverting option of the 74F645.

#### **Features**

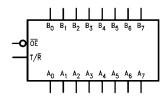
- Designed for asynchronous two-way data flow between busses
- Outputs sink 64 mA
- Transmit/receive (T/R) input controls the direction of data flow
- 74F645 is a lower power, faster version of the 74F245
- 74F640 is an inverting option of the 74F645

#### **Ordering Code:**

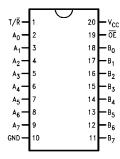
Order Number	Package Number	Package Description
74F640SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F640PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
74F645PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### **Logic Symbol**



#### **Connection Diagram**



# **Unit Loading/Fan Out**

Pin Names	Description	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>	
	Description	HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>	
ŌĒ	Output Enable Input (Active LOW)	1.0/1.0	20 μA/-0.6 mA	
T/R	Transmit/Receive Input	1.0/1.0	20 μA/-0.6 mA	
A <sub>0</sub> -A <sub>7</sub>	Side A Inputs or	3.5/0.667	70 μA/–0.4 mA	
	3-STATE Outputs	600/106.6	−12 mA/64 mA	
B <sub>0</sub> –B <sub>7</sub>	Side B Inputs or	3.5/0.667	70 μA/-0.4 mA	
	3-STATE Outputs	600/106.6	−12 mA/64 mA	

# **Functional Description**

The output enable  $(\overline{OE})$  is active LOW. If the device is disabled  $(\overline{OE}$  HIGH), the outputs are in the high impedance state. The transmit/receive input  $(T/\overline{R})$  controls whether data is transmitted from the  $\underline{A}$  bus to the B bus or from the B bus to the A bus. When  $T/\overline{R}$  is LOW, B data is sent to the A bus. If  $T/\overline{R}$  is HIGH, A data is sent to the B bus.

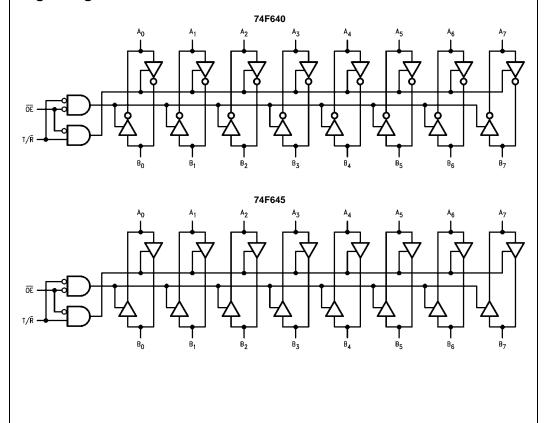
## **Function Table**

Inputs		Outputs				
OE         T/R         74F640		74F640	74F645			
L	L	Bus B data to Bus A	Bus B data to Bus A			
L	Н	Bus A data to Bus B	Bus A data to Bus B			
Н	Χ	Z	Z			

- H = HIGH Voltage Level

- L = LOW Voltage Level
  X = Don't Care
  Z = High Impedance State

# **Logic Diagram**



## **Absolute Maximum Ratings**(Note 1)

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$ 

 $\label{eq:Junction Temperature under Bias} $-55^{\circ}$C to +150^{\circ}$C$ $V_{CC}$ Pin Potential to Ground Pin $-0.5$V to +7.0$V $-1.5$V $-1.5$V to +7.0$V $-1.5$V $-1.$ 

Input Voltage (Note 2) -0.5V to +7.0V
Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Output in HIGH State (with V<sub>CC</sub> = 0V)

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{3-STATE Output} & -0.5 \text{V to +5.5V} \end{array}$ 

Current Applied to Output

# Recommended Operating Conditions

Free Air Ambient Temperature 0°C to +70°C Supply Voltage +4.5V to +5.5V

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

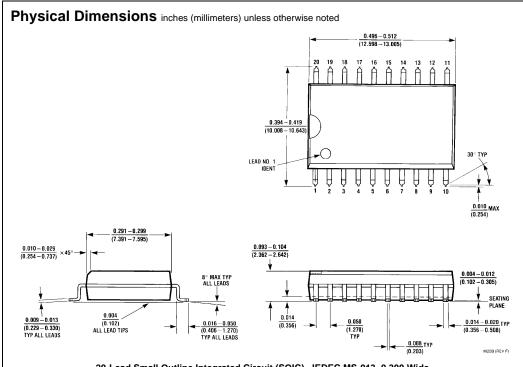
Symbol	Parameter	Min	Тур	Max	Units	v <sub>cc</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage			-1.2	V	Min	I <sub>IN</sub> = -18 mA (Non I/O Pins)
V <sub>OH</sub>	Output HIGH 10% V <sub>CC</sub>	2.0			V	Min	$I_{OH} = -15 \text{ mA } (A_n, B_n)$
V <sub>OL</sub>	Output LOW 10% V <sub>CC</sub>			0.55	V	Min	I <sub>OL</sub> = 64 mA (A <sub>n</sub> , B <sub>n</sub> )
I <sub>IH</sub>	Input HIGH Current			5.0	μА	Max	V <sub>IN</sub> = 2.7V (Non I/O Pins)
I <sub>BVI</sub>	Input HIGH Current Breakdown Test			7.0	μА	Max	V <sub>IN</sub> = 7.0V (Non I/O Pins)
I <sub>BVIT</sub>	Input HIGH Current Breakdown (I/O)			0.5	mA	Max	$V_{IN} = 5.5V (A_n, B_n)$
I <sub>CEX</sub>	Output HIGH Leakage Current			50	μА	Max	$V_{OUT} = V_{CC}$
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	$I_{ID} = 1.9 \mu A$ All Other Pins Grounded
I <sub>OD</sub>	Output Leakage Circuit Current			3.75	μА	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded
I <sub>IL</sub>	Input LOW Current			-0.6	mA	Max	V <sub>IN</sub> = 0.5V (Non I/O Pins)
I <sub>IH</sub> + I <sub>OZH</sub>	Output Leakage Current			70	μΑ	Max	$V_{OUT} = 2.7V (A_n, B_n)$
I <sub>IL</sub> + I <sub>OZL</sub>	Output Leakage Current			-650	μΑ	Max	$V_{OUT} = 0.5V (A_n, B_n)$
los	Output Short-Circuit Current	-100		-225	mA	Max	V <sub>OUT</sub> = 0V
I <sub>ZZ</sub>	Bus Drainage Test			500	μΑ	0.0V	V <sub>OUT</sub> = 5.25
Іссн	Power Supply Current (74F640)			80	mA	Max	$V_O = HIGH, V_{IN} = 0.2V$
I <sub>CCL</sub>	Power Supply Current (74F640)			80	mA	Max	$V_O = LOW$
I <sub>CCZ</sub>	Power Supply Current (74F640)			96	mA	Max	V <sub>O</sub> = HIGH Z
Іссн	Power Supply Current (74F645)			65	mA	Max	V <sub>O</sub> = HIGH
I <sub>CCL</sub>	Power Supply Current (74F645)			80	mA	Max	$V_O = LOW, V_{IN} = 0.2V$
I <sub>CCZ</sub>	Power Supply Current (74F645)			90	mA	Max	V <sub>O</sub> = HIGH Z

# **AC Electrical Characteristics** 74F640

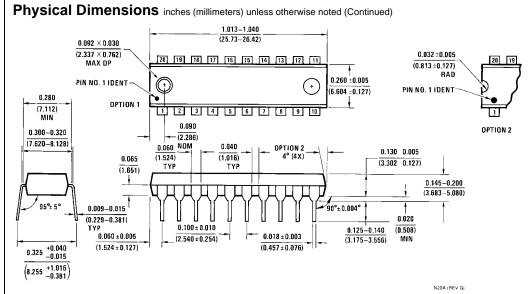
	Parameter	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$ $C_L = 50$ pF		Units
Symbol							
t <sub>PLH</sub>	Propagation Delay	2.5		7.5	2.0	8.0	ns
t <sub>PHL</sub>	A Input to B Output	2.0		7.0	2.0	7.0	115
t <sub>PLH</sub>	Propagation Delay	2.5		7.5	2.0	8.0	ns
t <sub>PHL</sub>	B Input to A Output	2.0		7.0	2.0	7.0	115
t <sub>PZH</sub>	Enable Time	2.5		7.5	2.0	9.0	ns
t <sub>PZL</sub>	OE Input to A Output	2.5		8.0	2.0	8.5	
t <sub>PHZ</sub>	Disable Time	1.5		7.0	1.0	7.5	
t <sub>PLZ</sub>	OE Input to A Output	1.5		6.0	1.5	6.0	
t <sub>PZH</sub>	Enable Time	2.5		7.5	2.0	9.0	ns
t <sub>PZL</sub>	OE Input to B Output	2.5		8.0	2.0	8.5	
t <sub>PHZ</sub>	Disable Time	1.5		7.0	1.0	7.5	1
t <sub>PLZ</sub>	OE Input to B Output	1.5		6.0	1.5	6.0	

# **AC Electrical Characteristics** 74F645

Symbol	Parameter	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			$T_A = 0$ °C to $+70$ °C $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		Units
		Min	Тур	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	1.5		6.0	1.5	7.0	ns
t <sub>PHL</sub>	A Input to B Output	2.0		7.0	2.0	7.5	115
t <sub>PLH</sub>	Propagation Delay	1.5		6.0	1.5	7.0	ns
t <sub>PHL</sub>	B Input to A Output	2.0		7.0	2.0	7.5	115
t <sub>PZH</sub>	Enable Time	2.5		8.0	2.0	9.0	ns
t <sub>PZL</sub>	OE Input to A Output	2.5		8.5	2.0	8.5	
t <sub>PHZ</sub>	Disable Time	1.5		7.0	1.0	8.0	
t <sub>PLZ</sub>	OE Input to A Output	1.0		5.5	1.0	5.5	
t <sub>PZH</sub>	Enable Time	2.5		7.5	2.0	9.5	ns
t <sub>PZL</sub>	OE Input to B Output	2.5		8.5	2.5	9.0	
t <sub>PHZ</sub>	Disable Time	1.5		6.5	1.0	7.5	
t <sub>PLZ</sub>	OE Input to B Output	1.0		5.5	1.0	5.5	



20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide Package Number M20B



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N20A

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